

## LMS5214 80mA, Low Dropout Voltage Regulator with Auto Discharge Function in SOT

Check for Samples: [LMS5214](#)

### FEATURES

- (Typical Unless Noted)
- Space Saving SOT Package
- Low Quiescent Current: 70 $\mu$ A
- Low Dropout Voltage: 2mV
- Stability With Low-ESR Ceramic Capacitors
- Auto Discharge
- Fast Turn-On
- Low Temperature Coefficient
- Current and Thermal Limiting
- Zero Current in Shutdown Mode
- Pin-to-Pin Compatible With LMS5213

### APPLICATIONS

- Cellular Phones
- Battery-Powered Equipment
- Bar Code Scanner
- Laptops, Notebooks, PDA's
- High-Efficiency Linear Power Supplies

### DESCRIPTION

The LMS5214 is a  $\mu$ Cap, low dropout voltage regulator with very low quiescent current, 110 $\mu$ A typical, at 80mA load. It also has very low dropout voltage, typically 2mV at light load and 300mV at 80mA.

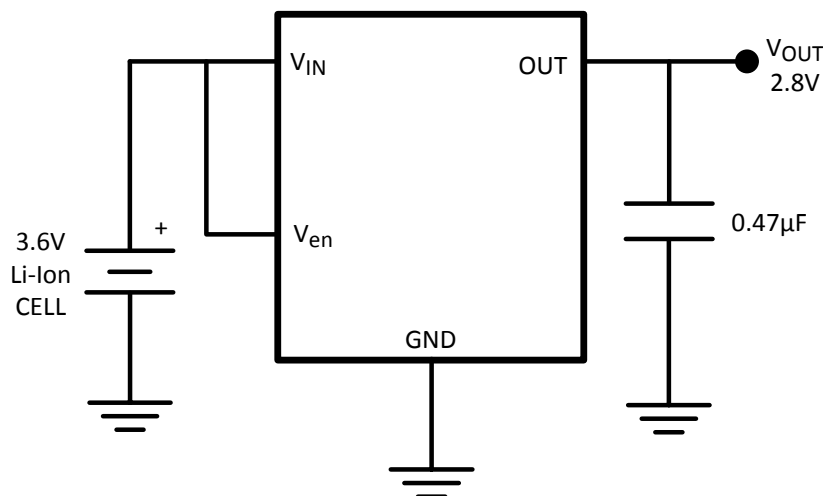
The LMS5214 is an enhanced version of the industry standard LMS5213 with auto discharge function which actively discharges the output voltage to ground when the device is placed in shutdown mode. It provides up to 80mA and consumes a typical of 10nA in disable mode, which helps to extend the battery life.

The LMS5214 is optimized to work with low value, low cost ceramic capacitors. The output typically requires only 470nF of output capacitance for stability. The enable pin can be tied to  $V_{IN}$  for easy device layout.

Low ground current at full load and small package makes the LMS5214 ideal for portable, battery powered equipment applications with small space requirements.

The LMS5214 is available in a space saving 5-pin SOT package. Performance is specified for the  $-40^{\circ}\text{C}$  to  $+125^{\circ}\text{C}$  temperature range and is available in 2.5V, 2.6V, 2.8V, 2.9V, 3.0V and 3.3V fixed voltages. For other output voltage options, please contact Texas Instruments.

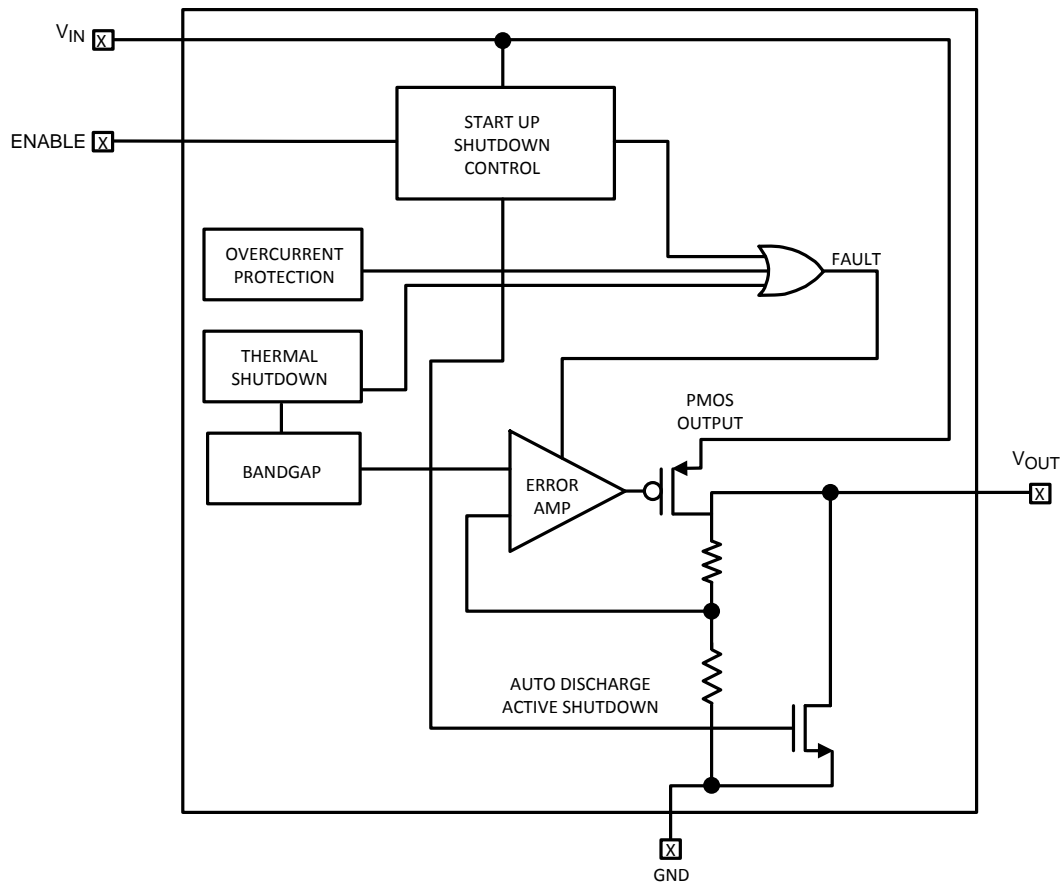
### TYPICAL APPLICATION



Please be aware that an important notice concerning availability, standard warranty, and use in critical applications of Texas Instruments semiconductor products and disclaimers thereto appears at the end of this data sheet.

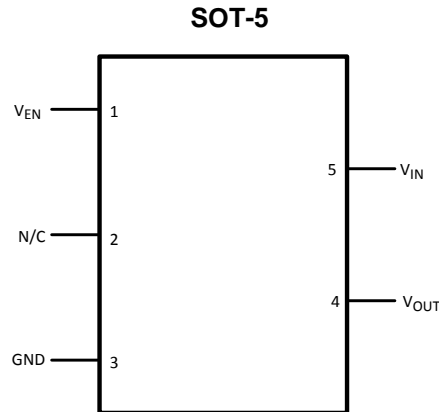
All trademarks are the property of their respective owners.

## SIMPLIFIED SCHEMATIC



## PIN DESCRIPTIONS

Pin Number	Pin Name	Pin Function
1	$V_{EN}$	Enable Input Logic, Logic High = Enabled Logic Low = Shutdown
2	NC	Not internally connected
3	GND	Ground
4	$V_{OUT}$	Output Voltage
5	$V_{IN}$	Input Voltage

**CONNECTION DIAGRAM**

**Figure 1. Top View**


These devices have limited built-in ESD protection. The leads should be shorted together or the device placed in conductive foam during storage or handling to prevent electrostatic damage to the MOS gates.

**ABSOLUTE MAXIMUM RATINGS<sup>(1)(2)</sup>**

ESD Tolerance <sup>(3)</sup>	Human Body Model	2000V
	Machine Model	200V
Junction Temperature		150°C
$V_{IN}$ , $V_{OUT}$ , $V_{EN}$		-0.3 TO 6.5V
Soldering Information	Infrared or Convection (20 sec)	235°C
	Wave Soldering (10 sec)	260°C (lead temp)

- (1) Absolute Maximum Ratings indicate limits beyond which damage to the device may occur. Operating Ratings indicate conditions for which the device is intended to be functional, but specific performance is not ensured. For ensured specifications and the test conditions, see the Electrical Characteristics.
- (2) If Military/Aerospace specified devices are required, please contact the Texas Instruments Sales Office/Distributors for availability and specifications.
- (3) Human body model, 1.5k $\Omega$  in series with 100pF.

**OPERATING RATINGS**

Supply Voltages	$V_{IN}$	2.5V to 6V
	$V_{EN}$	0V to $V_{IN}$
Junction Temp. Range <sup>(1)</sup>		-40°C to +125°C
Storage Temperature Range		-65°C to 150°C
Package Thermal Resistance	SOT-5	478°C/W

- (1) The maximum power dissipation is a function of  $T_{J(MAX)}$ ,  $\theta_{JA}$ , and  $T_A$ . The maximum allowable power dissipation at any ambient temperature is  $P_D = (T_{J(MAX)} - T_A) / \theta_{JA}$ . All numbers apply for packages soldered directly into a PC board.

## ELECTRICAL CHARACTERISTICS

Unless otherwise specified, all limits specified for  $T_J = 25^\circ\text{C}$ ,  $V_{IN} = V_{OUT} + 1\text{V}$ ,  $I_L = 1\text{mA}$ ,  $C_L = 0.47\mu\text{F}$ ,  $V_{EN} \geq 2.0\text{V}$ . **Boldface** limits apply at the temperature extremes.

Symbol	Parameter	Conditions	Min <sup>(1)</sup>	Typ <sup>(2)</sup>	Max <sup>(1)</sup>	Units
$V_O$	Output Voltage Accuracy		-3 <b>-4</b>		3 <b>4</b>	%
$\Delta V_O/\Delta T$	Output Voltage Temp. Coefficient	<sup>(3)</sup>		50	<b>200</b>	ppm/ $^\circ\text{C}$
$\Delta V_O/V_O$	Line Regulation	$V_{IN} = V_{OUT} + 1\text{V}$ to $6\text{V}$		0.008	0.3 <b>0.5</b>	%
$\Delta V_O/V_O$	Load Regulation	$I_L = 0.1\text{mA}$ to $80\text{mA}$ <sup>(4)</sup>		0.08	0.3 <b>0.5</b>	%
$V_{IN}-V_O$	Dropout Voltage <sup>(5)</sup>	$I_L = 100\mu\text{A}$		2		mV
		$I_L = 20\text{mA}$		70	<b>150</b>	
		$I_L = 50\text{mA}$		180		
		$I_L = 80\text{mA}$		300	<b>500</b>	
$I_Q$	Quiescent Current	$V_{EN} \leq 0.4\text{V}$ (Shutdown)		10	100	nA
$I_{GND}$	Ground Pin Current <sup>(6)</sup>	$I_L = 100\mu\text{A}$ , $V_{EN} \geq 2.0\text{V}$ (active)		70		$\mu\text{A}$
		$I_L = 20\text{mA}$ , $V_{EN} \geq 2.0\text{V}$ (active)		80	<b>135</b>	
		$I_L = 80\text{mA}$ , $V_{EN} \geq 2.0\text{V}$ (active)		110	<b>200</b>	
$I_{LIMIT}$	Current Limit	$V_{OUT} = 0\text{V}$		200	<b>400</b>	mA
$\Delta V_O/\Delta P_D$	Thermal Regulation	<sup>(7)</sup>		0.05		%W
<b>Enable Input</b>						
$V_{IL}$	Enable Input Voltage Level	Logic Low (off)			<b>0.6</b>	V
$V_{IH}$		Logic High (on)	<b>2.0</b>			V
$I_{IL}$	Enable Input Current	$V_{IL} \leq 0.6\text{V}$		0.01	<b>1</b>	$\mu\text{A}$
$I_{IH}$		$V_{IH} \geq 2.0\text{V}$		0.01	<b>5</b>	$\mu\text{A}$

(1) All limits are specified by testing or statistical analysis.

(2) Typical Values represent the most likely parametric norm.

(3) Output voltage temperature coefficient is defined as the worst-case voltage change divided by the total temperature range.

(4) Regulation is measured at constant junction temperature using low duty cycle pulse testing. Changes in output voltage due to heating effects are covered by the thermal regulation specification.

(5) Dropout voltage is defined as the input to output differential at which the output voltage drops 2% below its nominal value measured at 1V differential.

(6) Ground pin current is the regulator quiescent current plus pass transistor base current. The total current drawn from the supply is the sum of the load current plus the ground pin current.

(7) Thermal regulation is defined as the change in output voltage at a time "t" after a change in power dissipation is applied, excluding load or line regulation effects. Specifications are for an 80mA load pulse at  $V_{IN} = 6\text{V}$  for  $t = 16\text{ms}$ .

### TYPICAL CHARACTERISTICS

Unless otherwise specified,  $T_A = 25^\circ\text{C}$ ,  $V_{\text{OUT}} = 2.8\text{V}$ ,  $C_L = 0.47\mu\text{F}$

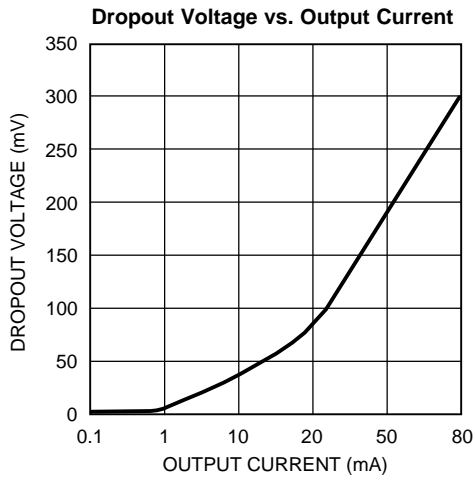


Figure 2.

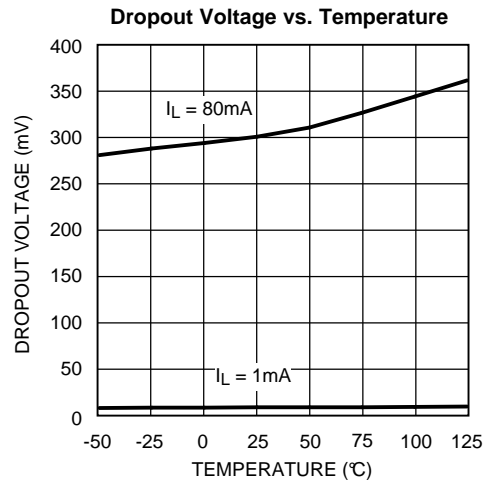


Figure 3.

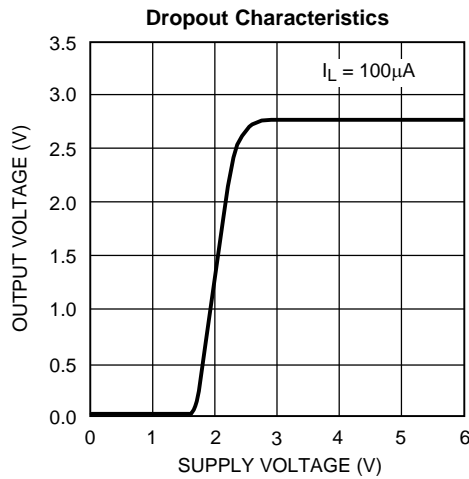


Figure 4.

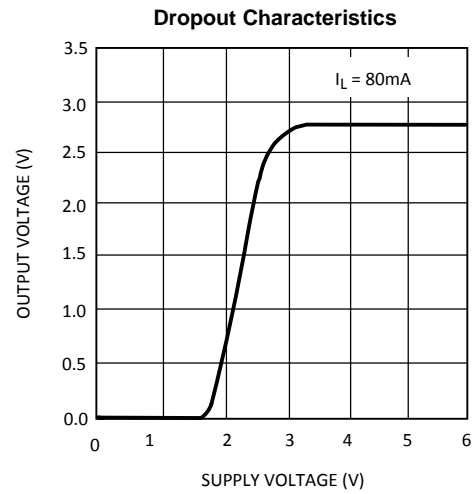


Figure 5.

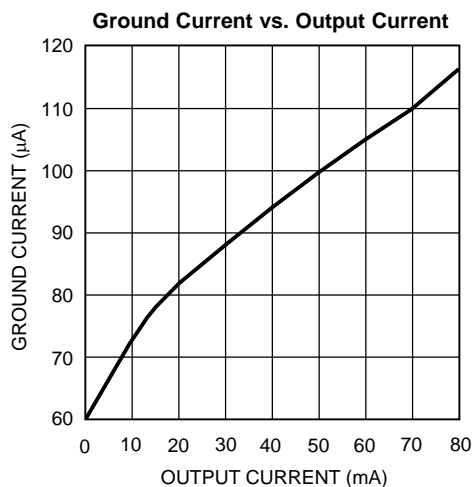


Figure 6.

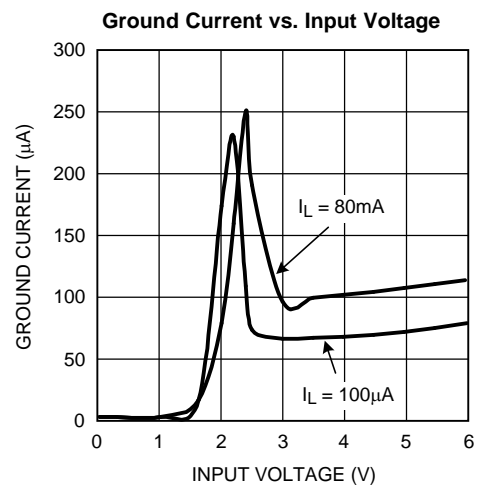


Figure 7.

### TYPICAL CHARACTERISTICS (continued)

Unless otherwise specified,  $T_A = 25^\circ\text{C}$ ,  $V_{\text{OUT}} = 2.8\text{V}$ ,  $C_L = 0.47\mu\text{F}$

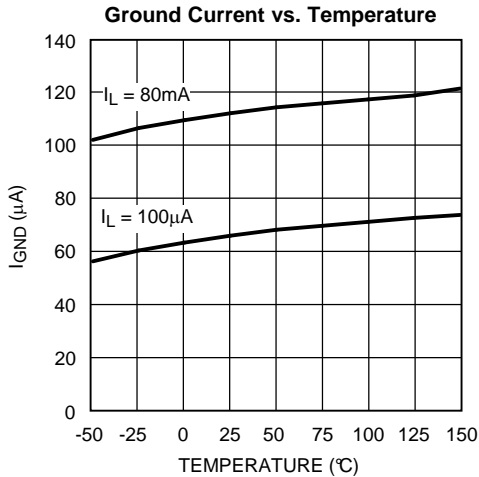


Figure 8.

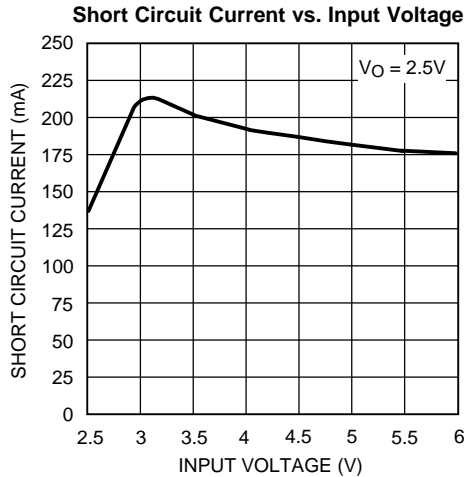


Figure 9.

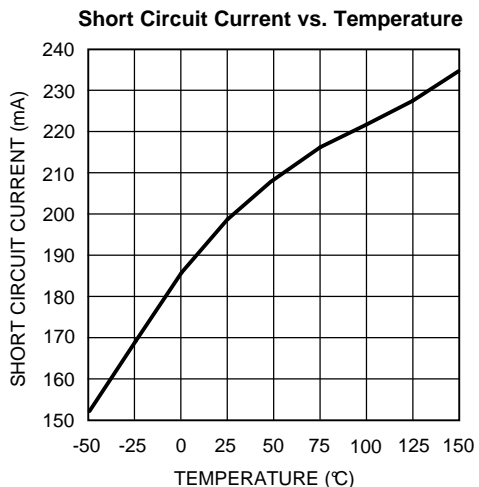


Figure 10.

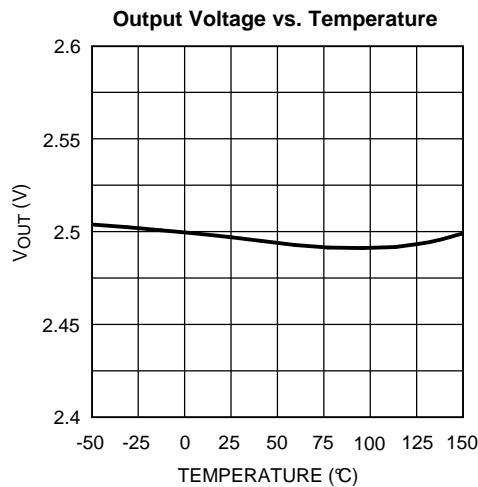


Figure 11.

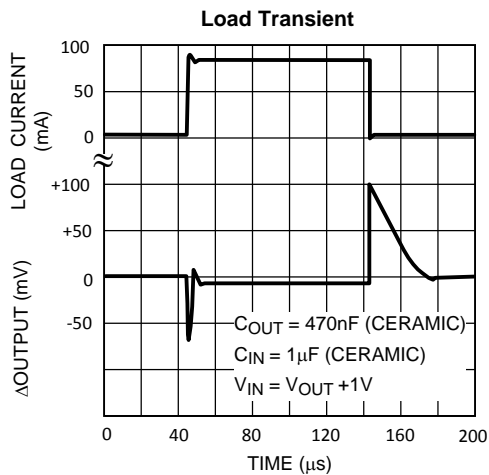


Figure 12.

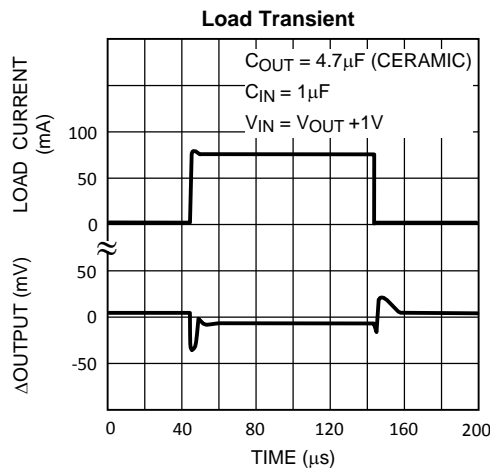


Figure 13.

**TYPICAL CHARACTERISTICS (continued)**

Unless otherwise specified,  $T_A = 25^\circ\text{C}$ ,  $V_{OUT} = 2.8\text{V}$ ,  $C_L = 0.47\mu\text{F}$

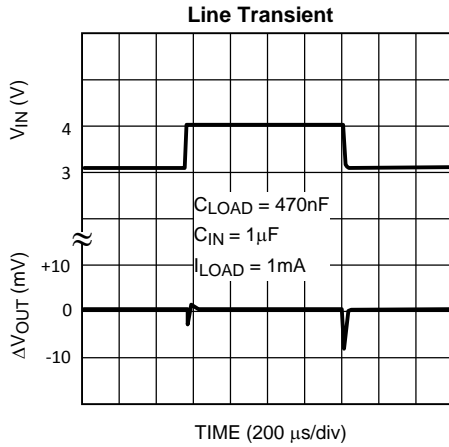


Figure 14.

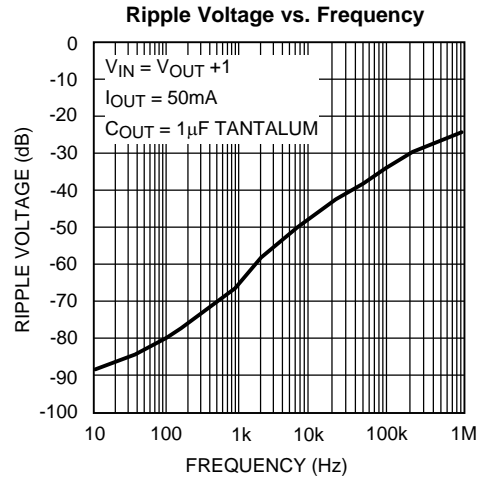


Figure 15.

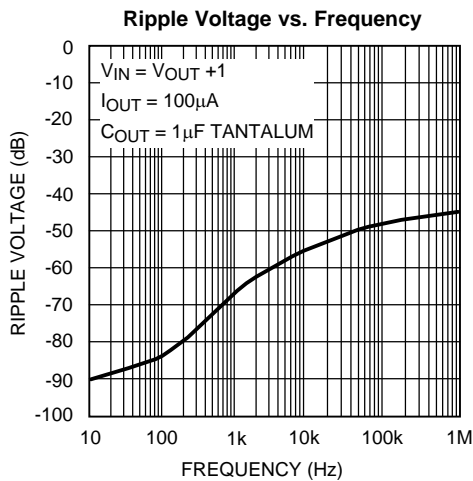


Figure 16.

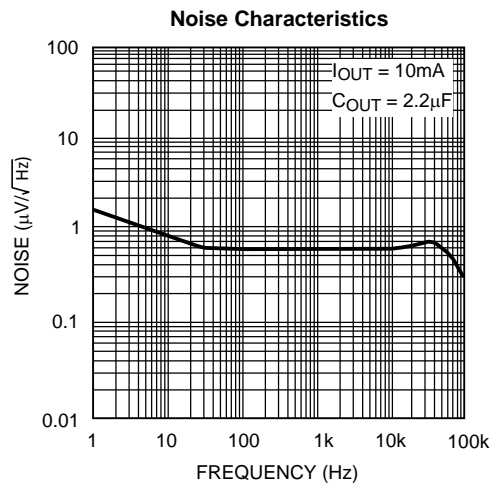


Figure 17.

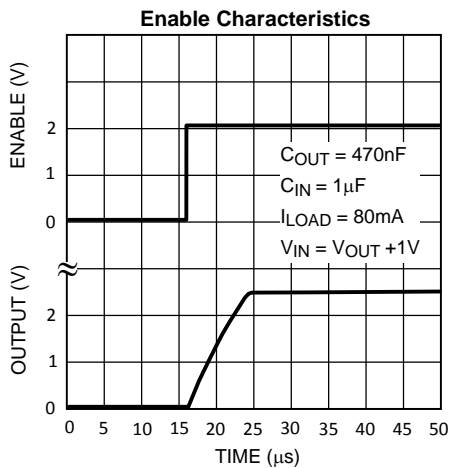


Figure 18.

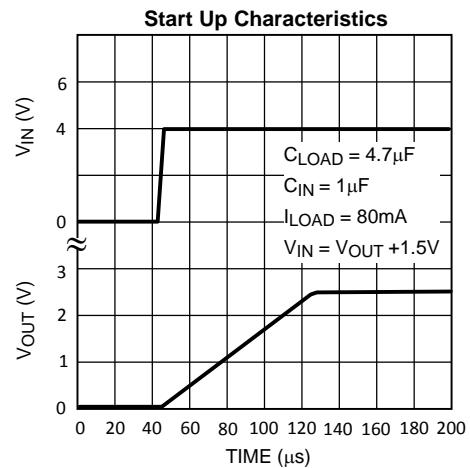
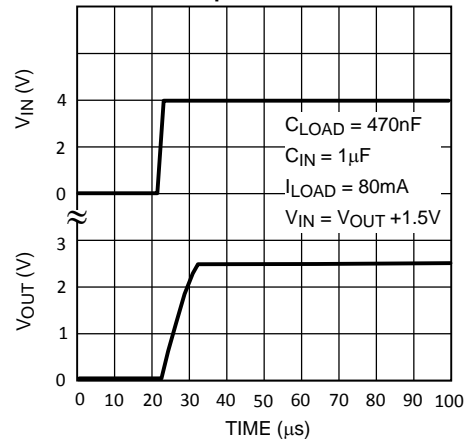


Figure 19.

**TYPICAL CHARACTERISTICS (continued)**Unless otherwise specified,  $T_A = 25^\circ\text{C}$ ,  $V_{\text{OUT}} = 2.8\text{V}$ ,  $C_L = 0.47\mu\text{F}$ **Start Up Characteristics**



## APPLICATION INFORMATION

The LMS5214 is a low dropout, linear regulator designed primarily for battery-powered applications. The LMS5214 can be used with low cost ceramic capacitors, typical value of 470nF.

The LMS5214 is an enhanced version of the LMS5213 with auto discharge function which actively discharges the output voltage to ground when the device is placed in shutdown mode

As illustrated in the simplified schematics, the LMS5214 consists of a 1.25V reference, error amplifier, P-channel pass transistor and internal feedback voltage divider. The 1.25V reference is connected to the input of the error amp. The error amp compares this reference with the feedback voltage. If the feedback voltage is lower than the reference, the pass transistor gate is pulled lower allowing more current to pass and increasing the output voltage. If the feedback voltage is too high, the pass transistor gate is pulled up allowing less current to pass to the output. The output voltage is feedback through the resistor divider. Additional blocks include short circuit current protection and thermal protection.

The LMS5214 features an 80mA P-channel MOSFET transistor. This provides several advantages over similar designs using PNP pass transistors including longer battery life.

The P-channel MOSFET requires no base drive, which reduces quiescent current considerably. PNP based regulators waste considerable amounts of current in dropout when the pass transistor saturates. They also have high base drive currents under large loads. The LMS5214 does not suffer from these problems and consumes only the specified quiescent current under light and heavy loads.

### External Capacitors

Like any low-dropout regulators, the LMS5214 requires external capacitors for regulator stability. The LMS5214 is specially designed for portable applications requiring minimum board space and the smallest components.

A 1 $\mu$ F capacitor should be placed from  $V_{IN}$  to GND if there is more than 10 inches of wire between the input and AC filter or when a battery is used as the input. This capacitor must be located a distance of not more than 1cm from the input pin and returned to a clean analog ground.

The LMS5214 is designed to work with high quality tantalum capacitors and small ceramic output capacitors. Ceramic capacitors ranging between 470nF to 4.7 $\mu$ F are the smallest and least expensive.

### No-Load Stability

The LMS5214 will remain stable and in regulation with no-load (other than the internal voltage divider). This is especially important in CMOS RAM keep-alive applications.

### Enable Input

The LMS5214 is shut off by pulling the  $V_{EN}$  pin below 0.6V; all internal circuitry is powered off and the quiescent current is typically 10nA. Pulling the  $V_{EN}$  high above 2V re-enables the device and allows operation. If the shut down feature is not used, the  $V_{EN}$  pin should be tied to  $V_{IN}$  to keep the regulator output on all the time.

### Thermal Behavior

The LMS5214 regulator has internal thermal shutdown to protect the device from over heating. Under all operating conditions, the maximum junction temperature of the LMS5214 must be below 125°C. Maximum power dissipation can be calculated based on the output current and the voltage drop across the part. The maximum power dissipation is

$$P_{D(MAX)} = (T_{J(MAX)} - T_A) / \theta_{JA}$$

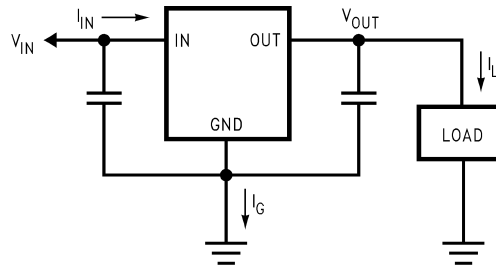
$\theta_{JA}$  is the junction-to-ambient thermal resistance, 478°C/W for the LMS5214 in the SOT package.  $T_A$  is the maximum ambient temperature  $T_{J(MAX)}$  is the maximum junction temperature of the die, 125°C

When operating the LMS5214 at room temperature, the maximum power dissipation is 209mW.

The actual power dissipated by the regulator is

$$P_D = (V_{IN} - V_{OUT}) I_L + V_{IN} I_{GND}$$

[Figure 20](#) shows the voltage and currents, which are present in the circuit.

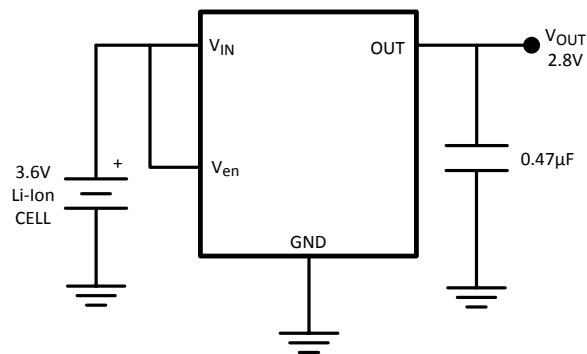


**Figure 20. Power Dissipation Diagram**

Substituting  $P_{D(MAX)}$ , determined above, for  $P_D$  and solving for the operating condition that are critical to the application will give the maximum operating conditions for the regulator circuit. To prevent the device from entering thermal shutdown, maximum power dissipation cannot be exceeded.

### Fixed Voltage Regulator

The LMS5214 offers a smaller system solution that is ideal for general-purpose voltage regulation in any handheld device.



**Figure 21. Single-Cell Regulator**

---

**REVISION HISTORY**

<b>Changes from Revision B (April 2013) to Revision C</b>	<b>Page</b>
• Changed layout of National Data Sheet to TI format .....	<a href="#">10</a>

---

## IMPORTANT NOTICE

Texas Instruments Incorporated and its subsidiaries (TI) reserve the right to make corrections, enhancements, improvements and other changes to its semiconductor products and services per JESD46, latest issue, and to discontinue any product or service per JESD48, latest issue. Buyers should obtain the latest relevant information before placing orders and should verify that such information is current and complete. All semiconductor products (also referred to herein as "components") are sold subject to TI's terms and conditions of sale supplied at the time of order acknowledgment.

TI warrants performance of its components to the specifications applicable at the time of sale, in accordance with the warranty in TI's terms and conditions of sale of semiconductor products. Testing and other quality control techniques are used to the extent TI deems necessary to support this warranty. Except where mandated by applicable law, testing of all parameters of each component is not necessarily performed.

TI assumes no liability for applications assistance or the design of Buyers' products. Buyers are responsible for their products and applications using TI components. To minimize the risks associated with Buyers' products and applications, Buyers should provide adequate design and operating safeguards.

TI does not warrant or represent that any license, either express or implied, is granted under any patent right, copyright, mask work right, or other intellectual property right relating to any combination, machine, or process in which TI components or services are used. Information published by TI regarding third-party products or services does not constitute a license to use such products or services or a warranty or endorsement thereof. Use of such information may require a license from a third party under the patents or other intellectual property of the third party, or a license from TI under the patents or other intellectual property of TI.

Reproduction of significant portions of TI information in TI data books or data sheets is permissible only if reproduction is without alteration and is accompanied by all associated warranties, conditions, limitations, and notices. TI is not responsible or liable for such altered documentation. Information of third parties may be subject to additional restrictions.

Resale of TI components or services with statements different from or beyond the parameters stated by TI for that component or service voids all express and any implied warranties for the associated TI component or service and is an unfair and deceptive business practice. TI is not responsible or liable for any such statements.

Buyer acknowledges and agrees that it is solely responsible for compliance with all legal, regulatory and safety-related requirements concerning its products, and any use of TI components in its applications, notwithstanding any applications-related information or support that may be provided by TI. Buyer represents and agrees that it has all the necessary expertise to create and implement safeguards which anticipate dangerous consequences of failures, monitor failures and their consequences, lessen the likelihood of failures that might cause harm and take appropriate remedial actions. Buyer will fully indemnify TI and its representatives against any damages arising out of the use of any TI components in safety-critical applications.

In some cases, TI components may be promoted specifically to facilitate safety-related applications. With such components, TI's goal is to help enable customers to design and create their own end-product solutions that meet applicable functional safety standards and requirements. Nonetheless, such components are subject to these terms.

No TI components are authorized for use in FDA Class III (or similar life-critical medical equipment) unless authorized officers of the parties have executed a special agreement specifically governing such use.

Only those TI components which TI has specifically designated as military grade or "enhanced plastic" are designed and intended for use in military/aerospace applications or environments. Buyer acknowledges and agrees that any military or aerospace use of TI components which have **not** been so designated is solely at the Buyer's risk, and that Buyer is solely responsible for compliance with all legal and regulatory requirements in connection with such use.

TI has specifically designated certain components as meeting ISO/TS16949 requirements, mainly for automotive use. In any case of use of non-designated products, TI will not be responsible for any failure to meet ISO/TS16949.

### Products

Audio	<a href="http://www.ti.com/audio">www.ti.com/audio</a>
Amplifiers	<a href="http://amplifier.ti.com">amplifier.ti.com</a>
Data Converters	<a href="http://dataconverter.ti.com">dataconverter.ti.com</a>
DLP® Products	<a href="http://www.dlp.com">www.dlp.com</a>
DSP	<a href="http://dsp.ti.com">dsp.ti.com</a>
Clocks and Timers	<a href="http://www.ti.com/clocks">www.ti.com/clocks</a>
Interface	<a href="http://interface.ti.com">interface.ti.com</a>
Logic	<a href="http://logic.ti.com">logic.ti.com</a>
Power Mgmt	<a href="http://power.ti.com">power.ti.com</a>
Microcontrollers	<a href="http://microcontroller.ti.com">microcontroller.ti.com</a>
RFID	<a href="http://www.ti-rfid.com">www.ti-rfid.com</a>
OMAP Applications Processors	<a href="http://www.ti.com/omap">www.ti.com/omap</a>
Wireless Connectivity	<a href="http://www.ti.com/wirelessconnectivity">www.ti.com/wirelessconnectivity</a>

### Applications

Automotive and Transportation	<a href="http://www.ti.com/automotive">www.ti.com/automotive</a>
Communications and Telecom	<a href="http://www.ti.com/communications">www.ti.com/communications</a>
Computers and Peripherals	<a href="http://www.ti.com/computers">www.ti.com/computers</a>
Consumer Electronics	<a href="http://www.ti.com/consumer-apps">www.ti.com/consumer-apps</a>
Energy and Lighting	<a href="http://www.ti.com/energy">www.ti.com/energy</a>
Industrial	<a href="http://www.ti.com/industrial">www.ti.com/industrial</a>
Medical	<a href="http://www.ti.com/medical">www.ti.com/medical</a>
Security	<a href="http://www.ti.com/security">www.ti.com/security</a>
Space, Avionics and Defense	<a href="http://www.ti.com/space-avionics-defense">www.ti.com/space-avionics-defense</a>
Video and Imaging	<a href="http://www.ti.com/video">www.ti.com/video</a>

### TI E2E Community

[e2e.ti.com](http://e2e.ti.com)